

09/22/2004

RELIABILITY REPORT FOR

DS21Q352, Rev B2

Dallas Semiconductor

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Prepared by:

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Conclusion:

The following qualification successfully meets the quality and reliability standards required of all Dallas Semiconductor products and processes:

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DS21Q352, Rev B2
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In addition, Dallas Semiconductor's continuous reliability monitor program ensures that all outgoing product will continue to meet Maxim's quality and reliability standards. The current status of the reliability monitor program can be viewed at http://www.maxim-ic.com/TechSupport /dsreliability.html.*

Module Description:

A description of this Module can be found in the product data sheet. You can find the product data sheet at http://dbserv.maxim-ic.com/l_datasheet3.cfm.*

Reliability Derating:

A module device consists of one or more IC's in a single, upward integrated, package. This package is assembled to include batteries, crystals, and other piece parts that make up the configuration of the Module. Because of either the complexity of the package or the included piece parts, standard high temperature reliability testing is not possible. Therefore, in order to determine the reliability of module products, the reliability of each of the piece parts is individually determined, then summed to determine the reliability of the integrated module product. If there are "n" significant components in the module then:

 $Fr (module) = Fr (1) + Fr (2) + Fr (3) + \dots + Fr (n)$ Fr (module) = Failure rate of module Fr(n) = Failure rate of the nth component

Failure Rates are reported in FITs (Failures in Time) or MTTF (Mean Time To Failure). The FIT rate is related to MTTF by:

MTTF = 1/Fr

NOTE: MTTF is frequently used interchangeably with MTBF.

The calculated failure rate for this module/assembly is:

| Module Device: | Module Units: | Quantity: | Fails: | <u>Ea:</u> | <u>MTTF (Yrs):</u> | <u>FITs:</u> |
|----------------|---------------|-----------|--------|------------|--------------------|--------------|
| DS21352 | 4 | 590 | 0 | 0.7 | 15504 | 7.4 |
| Totals: | | | | | 15504 | 7.4 |

The parameters used to calculate the module failure rate are as follows:

Cf: 60% Tu: 25 °C

The reliability data follows. A the start of this data is the module assembly information. This is a description of the module. The next section is the detailed reliability data for each stress found in the qualification / monitor. If there are additional processes or assemblies used as part of this report, a description of each will follow which includes the respective reliability data for that process/ assembly. The reliability data section includes the latest data available. Some of this data may be generic with other packages or products.

* Some proprietary products may be excepted from this requirement.

| DESCRIPTION | DATE CD | CONDITION | READ | POINT | QTY | FAILS | FA# |
|------------------------------------|---------|-------------------------------|------------|-------------|--------|--------|-----|
| PACKAGE TESTS | | | | | | | |
| | | | | Total: | - | 0 | |
| HIGH VOLTAGE LIFE | 9917 | 125C, 3.5 VOLTS | 2000 | HRS | 48 | 0 | |
| INFANT LIFE | 9917 | 125C, 3.5 VOLTS | 48 | HRS | 200 | 0 | |
| HIGH VOLTAGE LIFE | 9844 | 125C, 3.5 VOLTS | 2000 | HRS | 48 | 0 | |
| INFANT LIFE | 9844 | 125C, 3.5 VOLTS | 48 | HRS | 200 | 0 | |
| DESCRIPTION | DATE CD | CONDITION | READ | READPOINT | | FAILS | FA# |
| OPERATING LIFE | | | | | | | |
| | | | | Total: | - | 0 | |
| EXTERNAL VISUAL | | MIL-STD-883-2009 | 3 | DYS | 8 | 0 | |
| MOISTURE SOAK CONVECTION REFLOW | | 30C/60% R.H. 220C | 144 3 | HRS PASS | 8 8 | 0 | |
| STORAGE LIFE | | 125C | 24 | HRS | 8 | | |
| ULTRASOUND | | J-STD-020 | 4 | DYS | 8 | 0 | |
| PRECONDITION U/S | 9917 | J-STD-020 | 4 | DYS | 8 | 0 | |
| EXTERNAL VISUAL | | MIL-STD-883-2009 | 174 | DYS | 8 | 0 | |
| CONVECTION REFLOW | | 220C | 3 | PASS | 8 | 0 | |
| MOISTURE SOAK | | 30C/60% R.H. | 144 | HRS | 8 | | |
| STORAGE LIFE | | 125C | 24 | HRS | 8 | č | |
| PRECONDITION U/S ULTRASOUND | 9844 | J-STD-020 J-STD-020 | 175 175 | DYS DYS | 8 8 | 0 0 | |
| | - | J-STD-020 | | DVS | | FAILS | FA# |
| MOISTURE SENSITIV | | | | | OTV | | |
| Date Code Range | | 9844 to 9917 | | | | | |
| (JEDEC J-STD2 | • | 0044 to 0047 | | | | | |
| Moisture Sensitivi | | Level 4 | | | | | |
| Flammability: | | UL 94-V0 | | | | | |
| Bond Wire / Size: | | Au / 1.2 mil | | | | | |
| Lead Finsh: Die Attach: | | A8510AA Silverfilled Ablestik | | | | | |
| Lead Frame: | | PCB; BT | | | | | |
| Mold Compound: | | Plaskon SMT-B1 | | | | | |
| Body Size: | | 27x27x1.73 | | | | | |
| Pin Count: Package Type: | | 300 MCMBGA | | | | | |
| - | | Stats | | | | | |
| Assembly Site: | | Ctoto | | | | | |

| CONSTRUCTION ANALYSIS | 9844 | TO BE DONE BY F/A | 2 | WKS | 5 | 0 | |
|-----------------------------------------|----------------------------------------------------|------------------------------------|--------------|---------------|------------------|--------------|-----|
| X-RAY | 9844 | MIL-STD-883-2012 : TOP & SIDE VIEW | 1 | DYS | 6 | 0 | |
| PHYSICAL DIMENSIONS | 6 | MIL-STD-883-2016 | 2 | DYS | 6 | 0 | |
| MARK PERMANENCY | | MIL-STD-883-2015 | 3 | DYS | 6 | 0 | |
| BALL SHEAR | | TBD | 4 | DYS | 6 | 0 | |
| X-RAY | 9917 | MIL-STD-883-2012 : TOP & SIDE VIEW | 2 | DYS | 6 | 0 | |
| PHYSICAL DIMENSIONS | 6 | MIL-STD-883-2016 | 2 | DYS | 6 | 0 | |
| MARK PERMANENCY | | MIL-STD-883-2015 | 2 | DYS | 6 | 0 | |
| BALL SHEAR | | TBD | 2 | DYS | 6 | 0 | |
| | | | | Total: | | 0 | |
| TEMPERATURE CYCLE | | | | | | | |
| TEMPERATURE CYC | LE | | | | | | |
| TEMPERATURE CYC DESCRIPTION | | CONDITION | READ | DPOINT | QTY | FAILS | FA# |
| | | CONDITION -55C TO 125C | | DPOINT CYS | QTY 77 | FAILS | FA# |
| DESCRIPTION | DATE CD | | 1000 | - | - | - | FA# |
| DESCRIPTION TEMP CYCLE | DATE CD 9844 | -55C TO 125C | 1000 | CYS | 77 | 0 | FA# |
| DESCRIPTION TEMP CYCLE | DATE CD 9844 9917 | -55C TO 125C -55C TO 125C | 1000 | CYS CYS | 77 | 0 0 | FA# |
| DESCRIPTION TEMP CYCLE TEMP CYCLE | DATE CD 9844 9917 IDITY BIA | -55C TO 125C -55C TO 125C | 1000 1000 | CYS CYS | 77 83 | 0 0 | FA# |

BIASED MOISTURE

9917 85/85, 3.5 VOLTS

27 0 2

959 HRS

Total: